

## ReleaSys™ Product Guide

### Water-Based, Semi-Permanent Mold Release

#### ReleaSys™ Benefits:

- Cost-Effective, Efficient Release
- Superior Durability and Surface Adhesion
- Multiple Releases Per Application
- Minimal Transfer to Molded Product
- Solvent-free; VOC-free

	<i>Release Type</i>	<i>Carrier Solvent</i>	<i>Application Specifics</i>	<i>Compound Compatibility</i>	<i>Finish</i>	<i>Cure Temp/ Time</i>	<i>Max Operating Temperature</i>
<b>ReleaSys™ 8500</b>	Semi-Permanent (Thermoset Polysiloxane)	Water	General Purpose, low complexity molds: Injection, transfer	Fluoroelastomers, EPDM, Butyl, Ethylene Acrylics, Plastics (Urethane, ABS)	Matte	132°C (270°F) for 3 mins	200°C (392°F)
<b>ReleaSys™ 8800</b>	Semi-Permanent (Thermoset Polysiloxane)	Water	Intricate mold geometries, Highest Slip. Compression Transfer, RIM Injection	Organic Polymers, Fluoroelastomers, EPDM, Organic and Synthetic Rubber, Plastics, Extrusion PU, Neoprene	Matte	132°C (270°F) for 3 mins	200°C (392°F)
<b>ReleaSys™ 8200</b>	Semi-Permanent (Fluoro-polymer)	Water	Ideal for Silicone containing compounds. Compression Transfer	Fluorosilicones, Nitrile, SBR, Natural and Synthetic Rubber, Chlorinated Polyethylenebutadiene	Matte	132°C (270°F) for 3 mins	327°C (620°F)